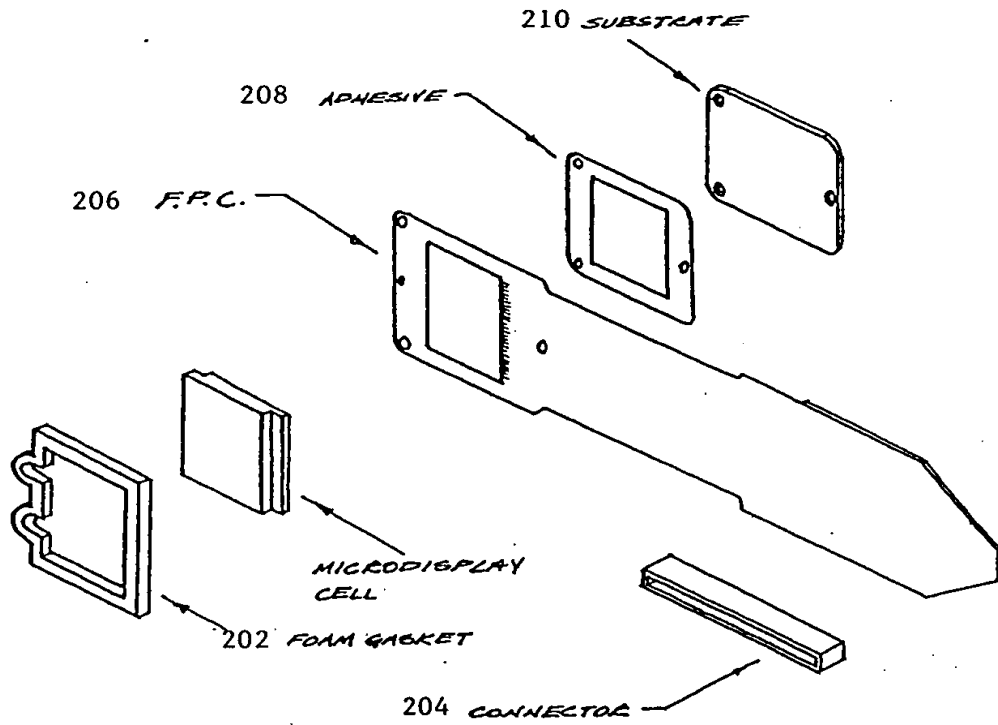


*L. Edwards*

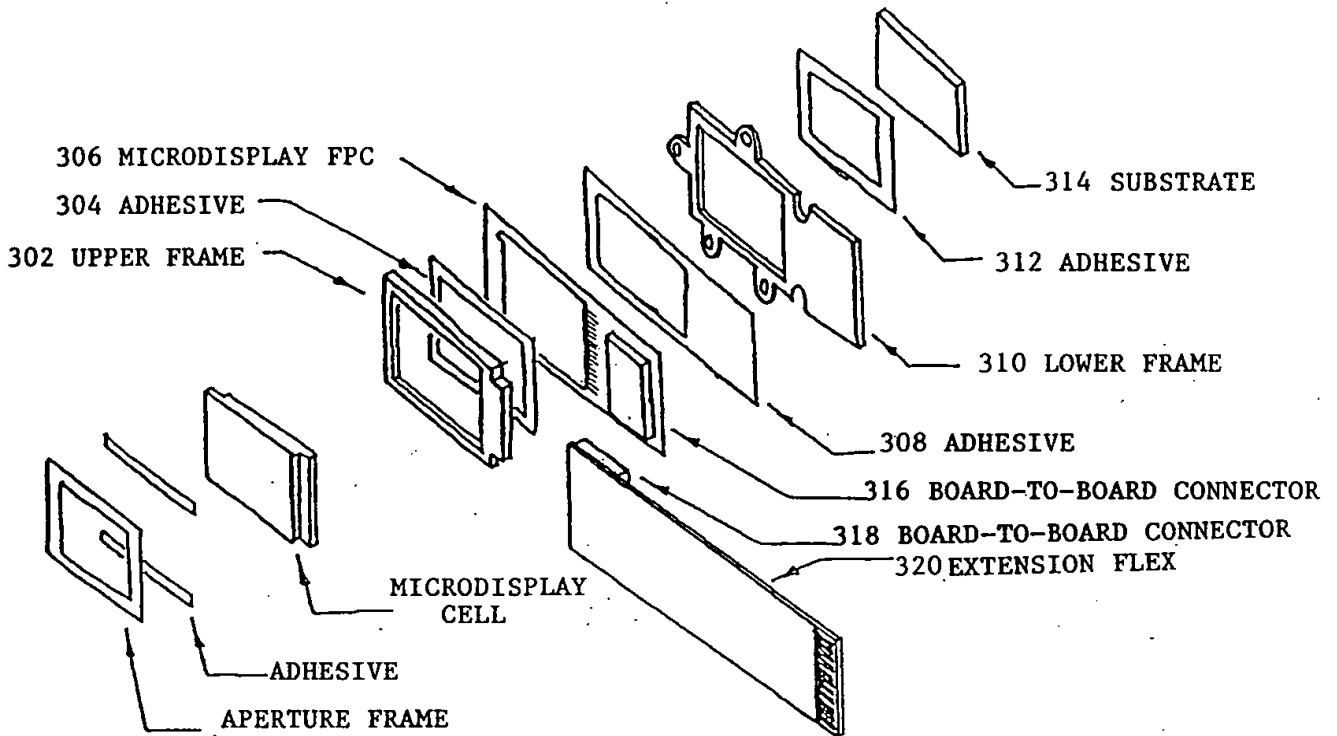
Figure 1: Exploded view of Art 1.  
(Prior Art)

Inventor: Nicoll Ryan Edwards et al.  
Docket No.: 50028.03USU1  
Title: METHOD AND APPARATUS TO PACKAGE  
ELECTRICALLY CONNECT TO A MICRODISPL



*R. Edwards*

Figure 2: Exploded view of Art 2.  
(Prior Art)



L. EDWARDS

Figure 3: Exploded view of Art 3.  
(Prior Art)

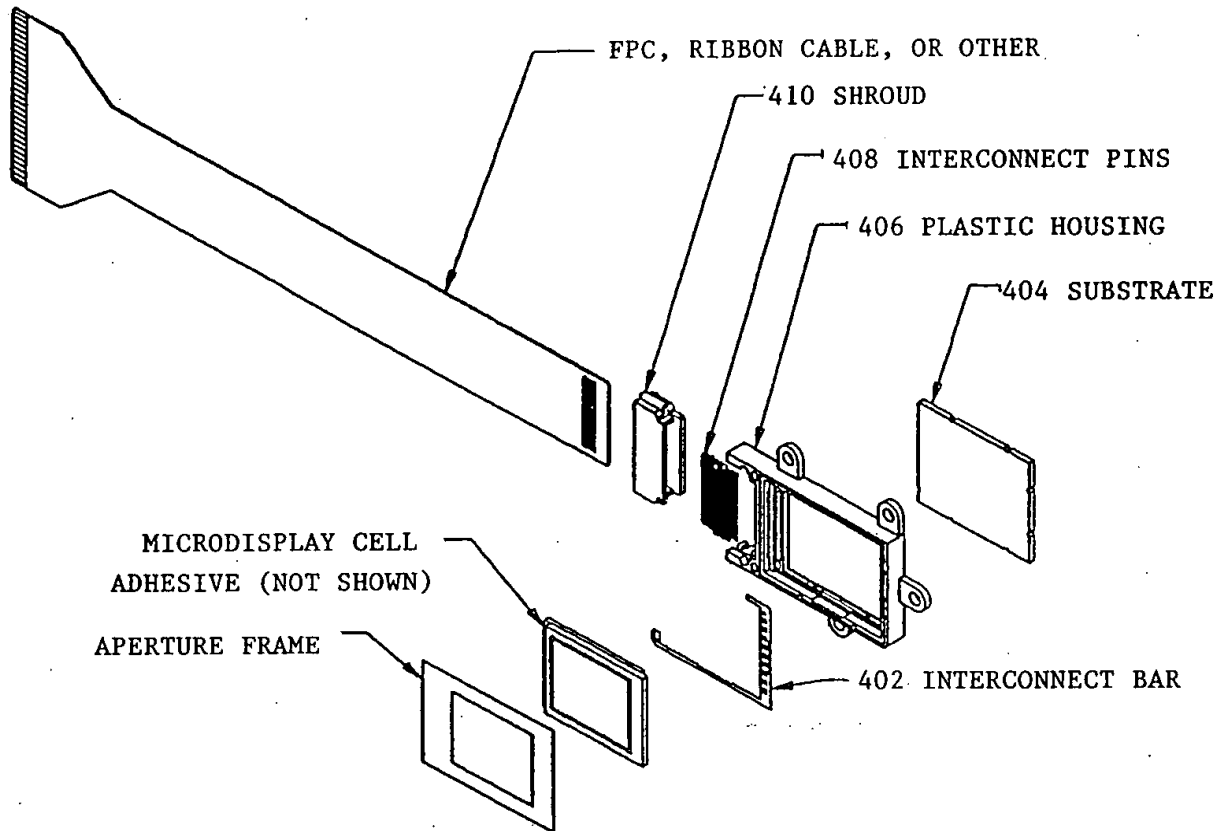


Figure 4: Exploded view of one Embodiment of the Invention

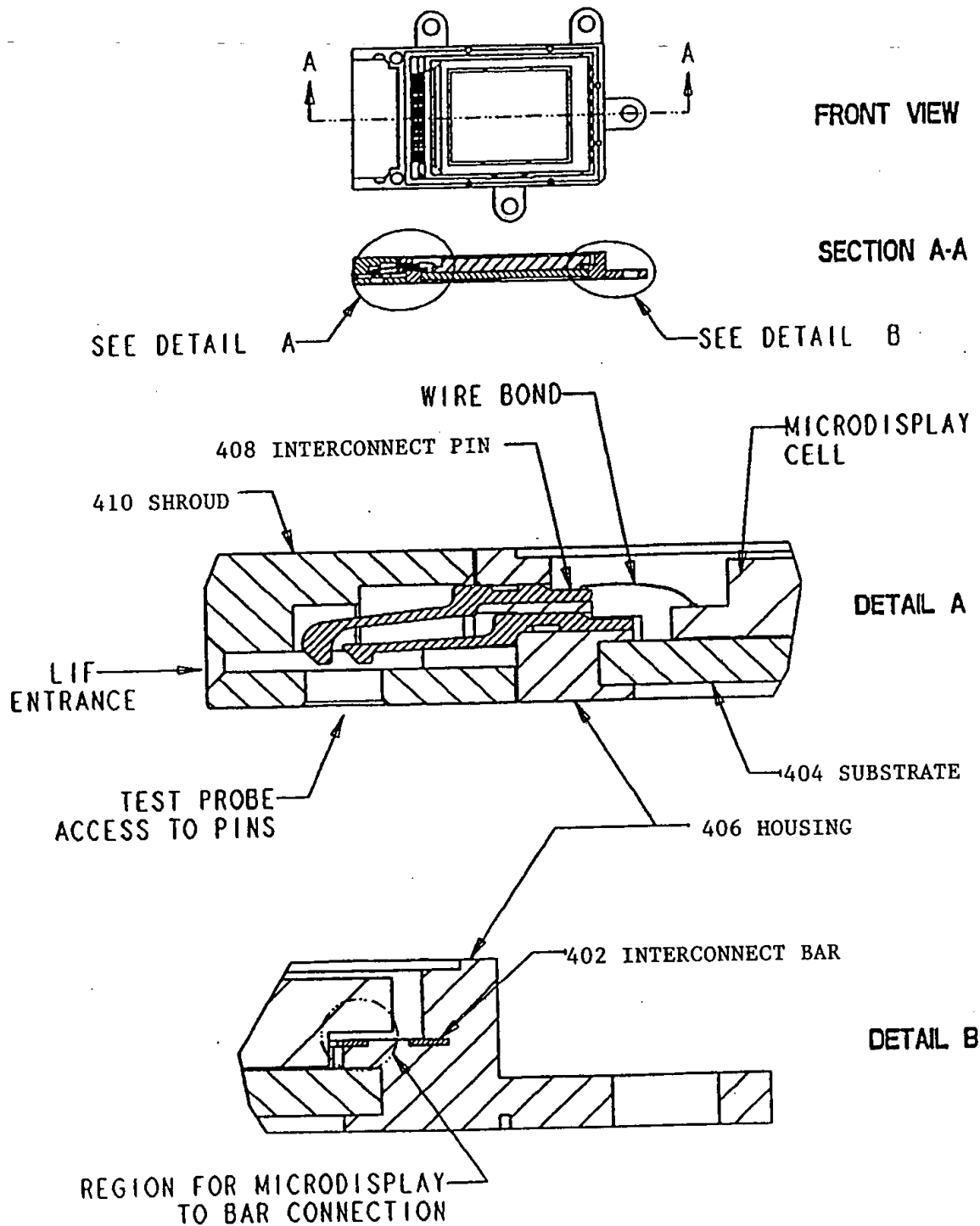


Figure 5: Detail A illustrates the pin to microdisplay wire bond and the test probe access to the Design's pins. Detail B shows the interconnect bar to microdisplay connection.